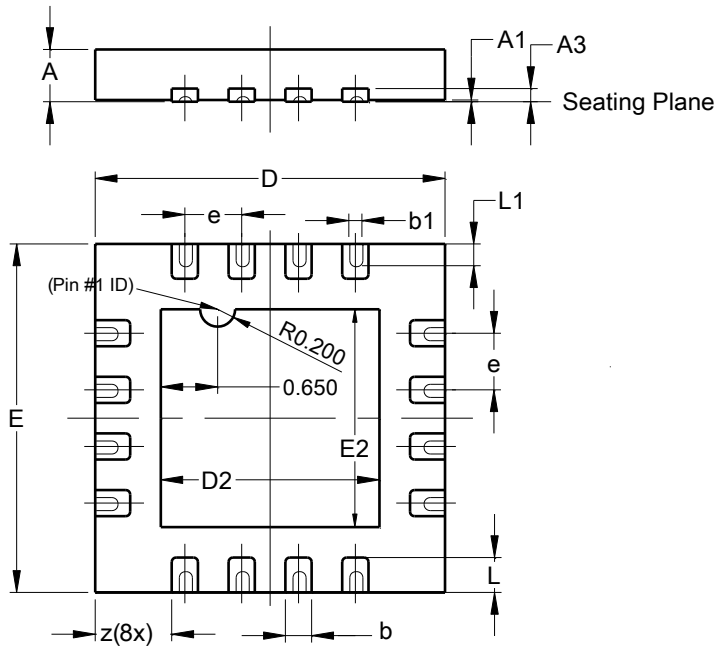


## Package Outline Dimensions

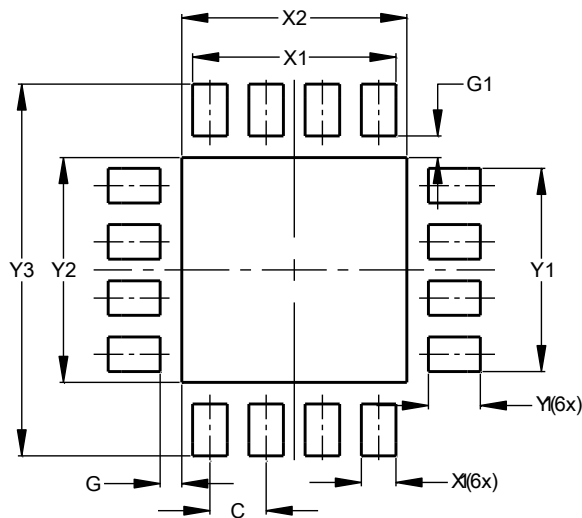
U-QFN4040-16/SWP (Type UXB)



U-QFN4040-16/SWP (Type UXB)			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0.00	0.05	0.02
A3	--	--	0.15
b	0.25	0.35	0.30
b1	--	--	0.15
D	3.95	4.05	4.00
D2	2.40	2.60	2.50
E	3.95	4.05	4.00
E2	2.40	2.60	2.50
e	--	--	0.65
L	0.35	0.45	0.40
L1	--	--	0.25
z	0.850	0.900	0.875
All Dimensions in mm			

## Suggested Pad Layout

U-QFN4040-16/SWP (Type UXB)



Dimensions	Value (in mm)
C	0.650
G	0.250
G1	0.250
X	0.400
X1	2.350
X2	2.600
Y	0.600
Y1	2.350
Y2	2.600
Y3	4.300

### ALL DIMENSIONS ARE NOMINAL VALUES SHOWN IN MILLIMETERS

Note: The suggested land pattern dimensions have been provided for reference only, as actual pad layouts may vary depending on application. These numbers may be modified based on user equipment capability or fabrication criteria. A more robust pattern may be desired for wave soldering and is calculated by adding 0.2 mm to the 'Z' dimension. For further information, please reference document IPC-7351A, Naming Convention for Standard SMT Land Patterns, and for International grid details, please see document IEC, Publication 97.

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